

US00D501008S

(12) **United States Design Patent**  
**Lin**

(10) **Patent No.:** **US D501,008 S**  
(45) **Date of Patent:** **\*\* Jan. 18, 2005**

(54) **COMPUTER MAINFRAME FRONT PANEL**

D459,357 S \* 6/2002 Lo ..... D14/444

(75) **Inventor:** **Pei-Shi Lin, Taipei Hsien (TW)**

\* cited by examiner

(73) **Assignee:** **Thermaltake Technology Co., Ltd., Taipei Hsien (TW)**

*Primary Examiner*—Freda S. Nunn

(74) *Attorney, Agent, or Firm*—Rosenberg, Klein & Lee

(\*\*) **Term:** **14 Years**

(57) **CLAIM**

The ornamental design for a computer mainframe front panel, as shown and described.

(21) **Appl. No.:** **29/201,378**

(22) **Filed:** **Mar. 16, 2004**

**DESCRIPTION**

(51) **LOC (7) Cl.** ..... **14-02**

(52) **U.S. Cl.** ..... **D14/444**

(58) **Field of Search** ..... D14/441-446;  
D13/162, 184, 199; 312/223.2; 361/680-686,  
690-696

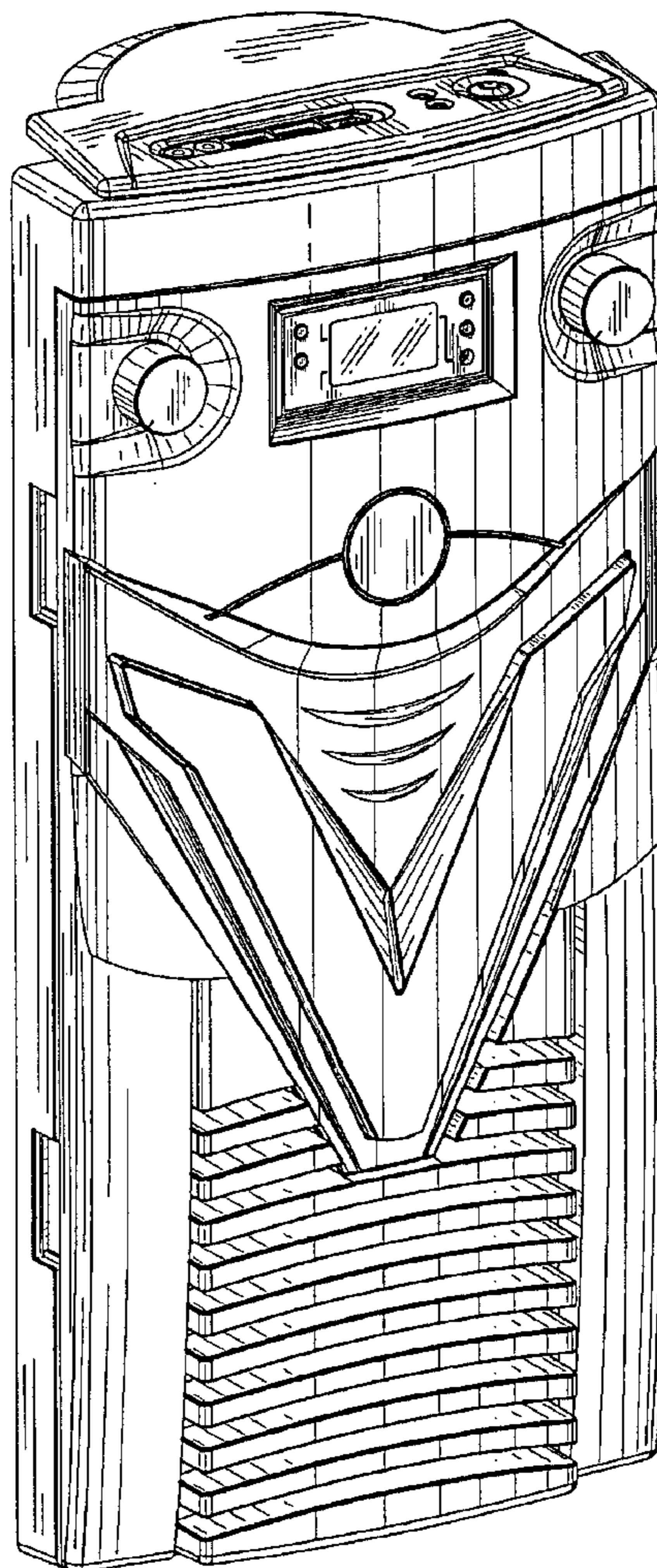
FIG. 1 is a top, front and right side perspective view of a computer mainframe front panel showing my new design; FIG. 2 is a front elevational view thereof; FIG. 3 is a rear elevational view thereof; FIG. 4 is a left side elevational view thereof; FIG. 5 is a right side elevational view thereof; FIG. 6 is a top plan view thereof; FIG. 7 is a bottom plan view thereof; and, FIG. 8 is a top, front and left side perspective view thereof.

(56) **References Cited**

**U.S. PATENT DOCUMENTS**

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**1 Claim, 6 Drawing Sheets**



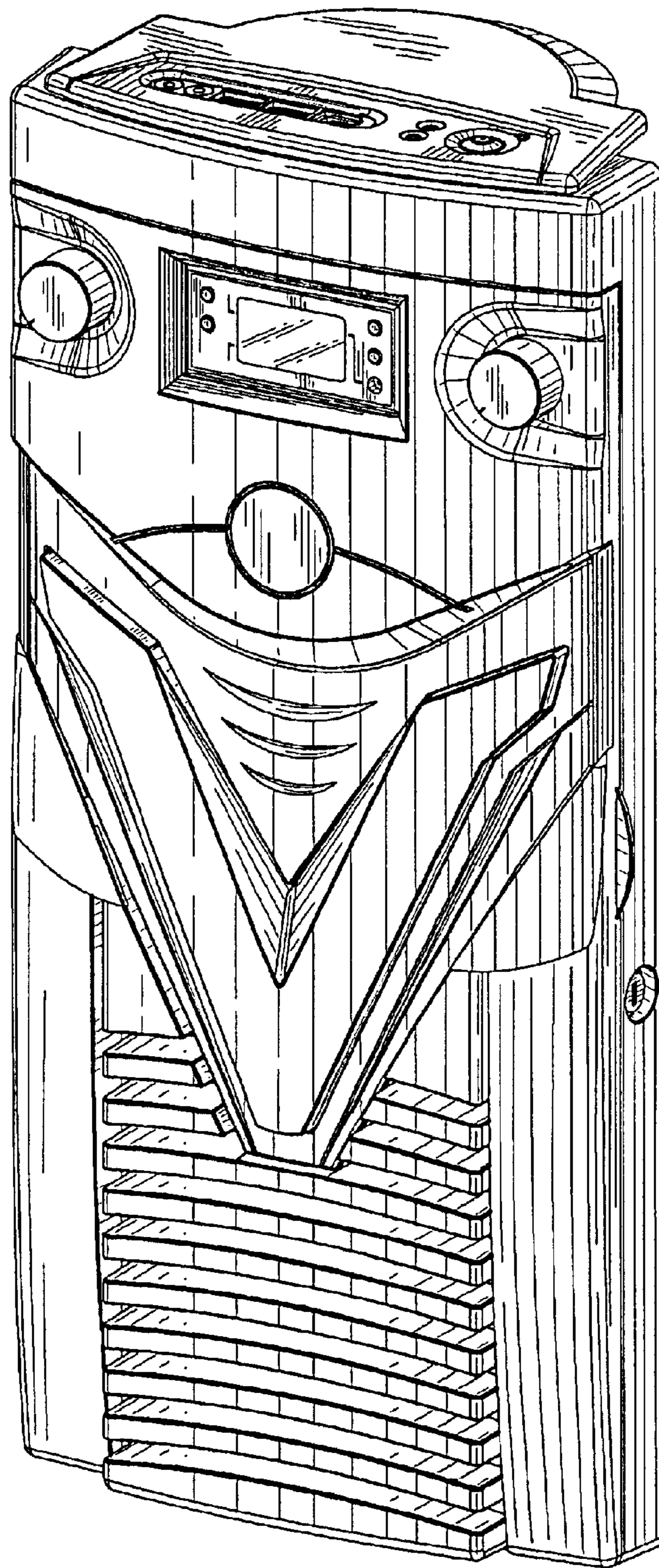


FIG. 1

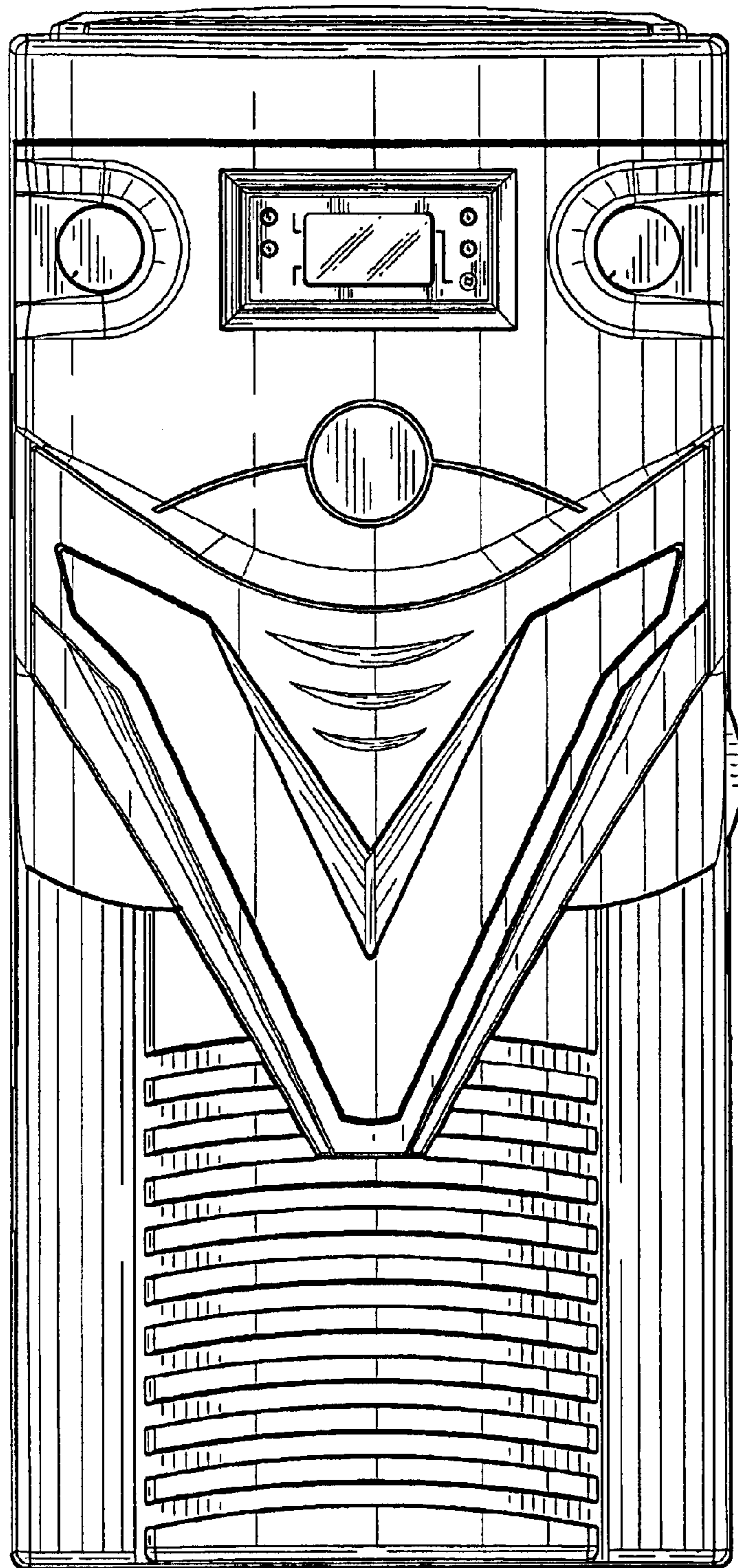


FIG. 2



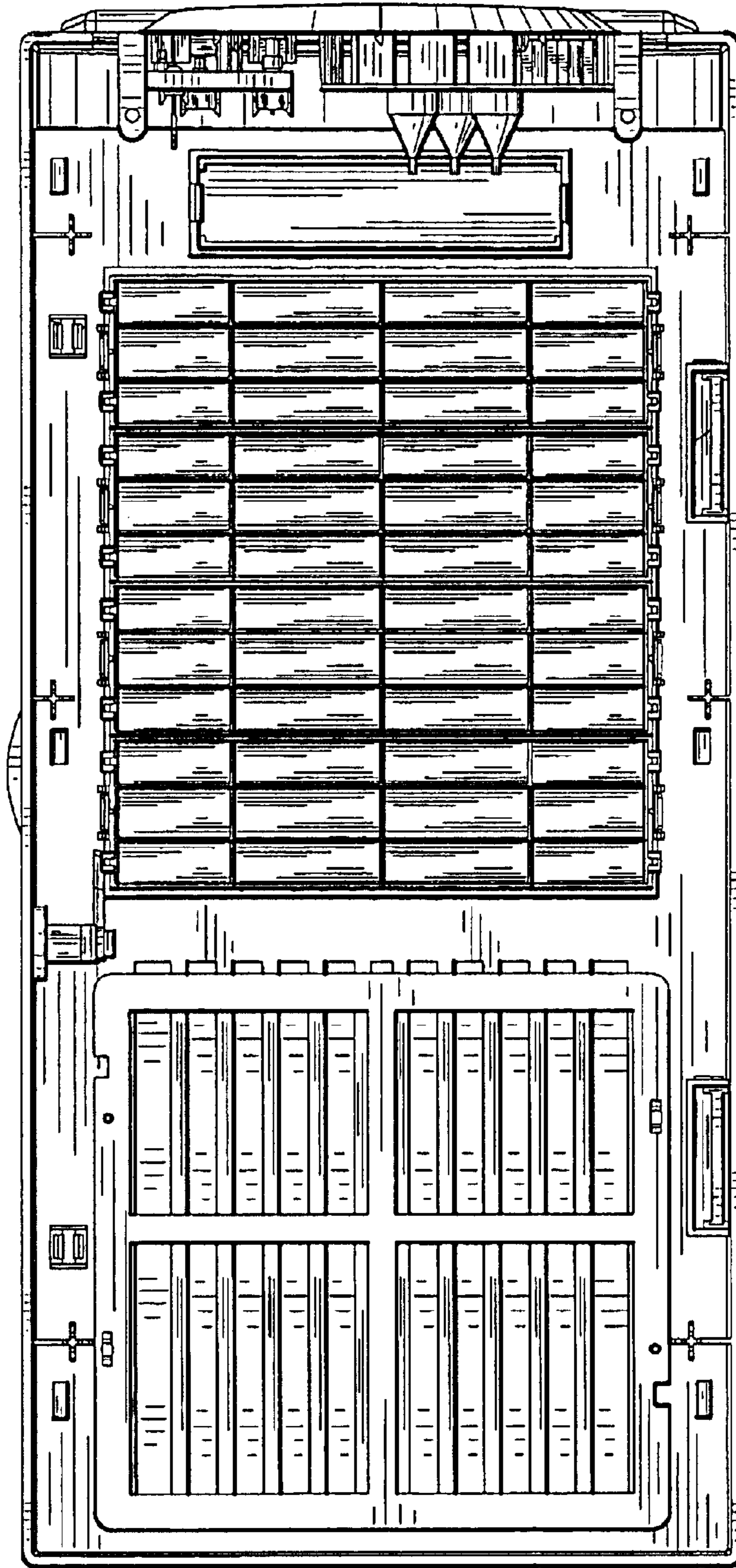


FIG. 3

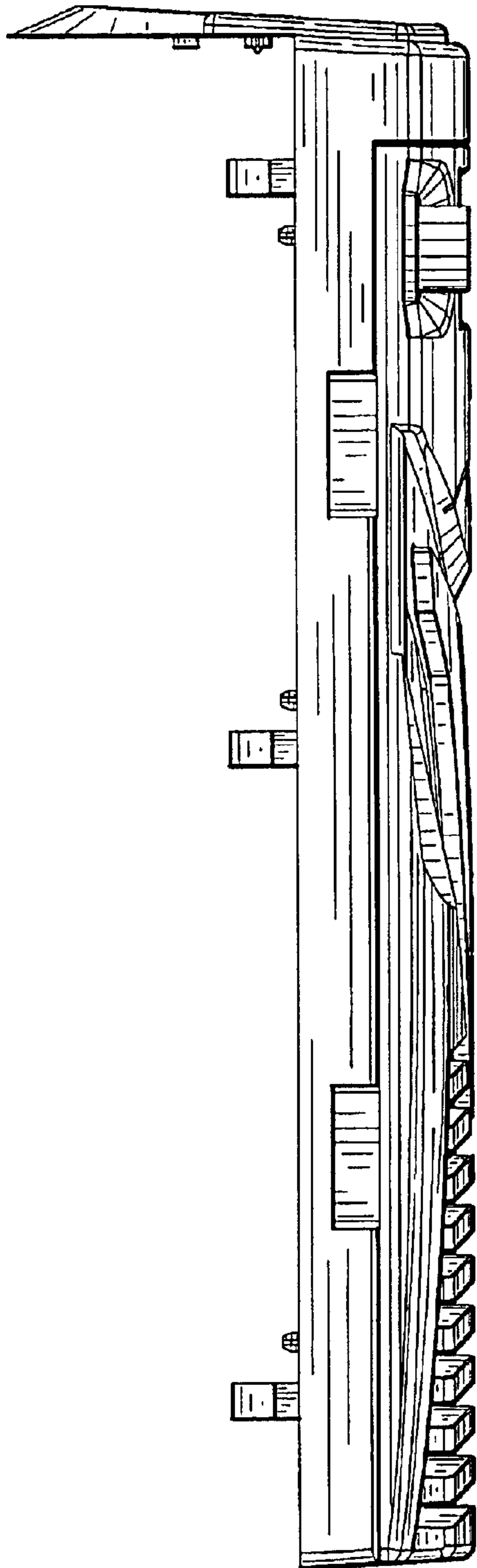


FIG. 4

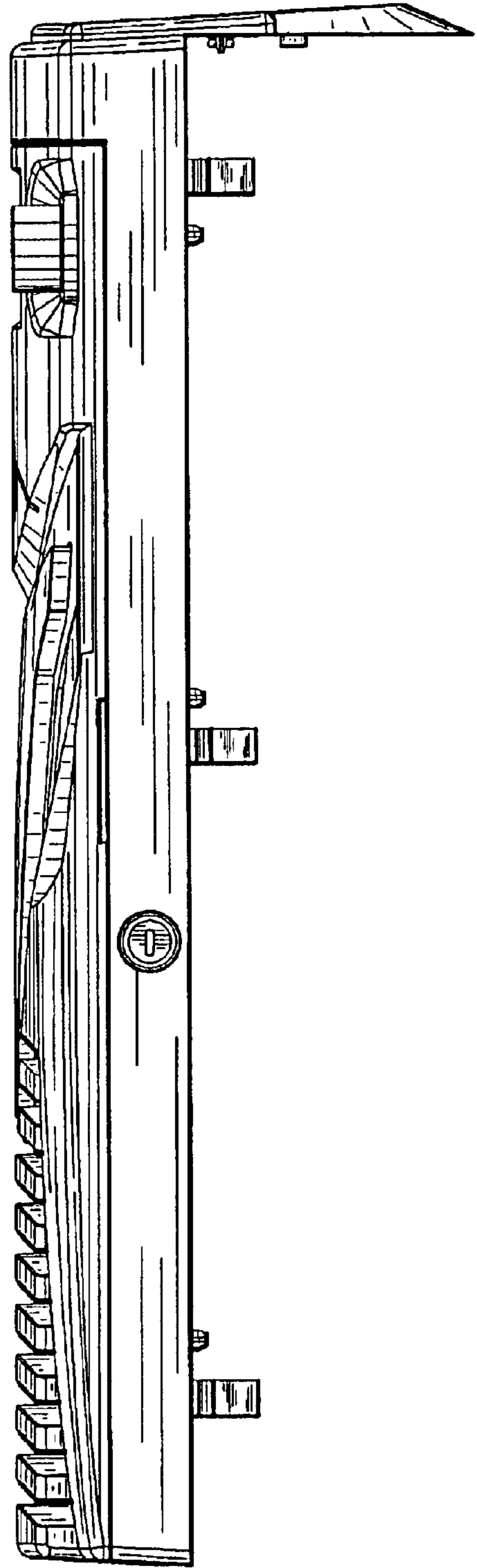


FIG. 5

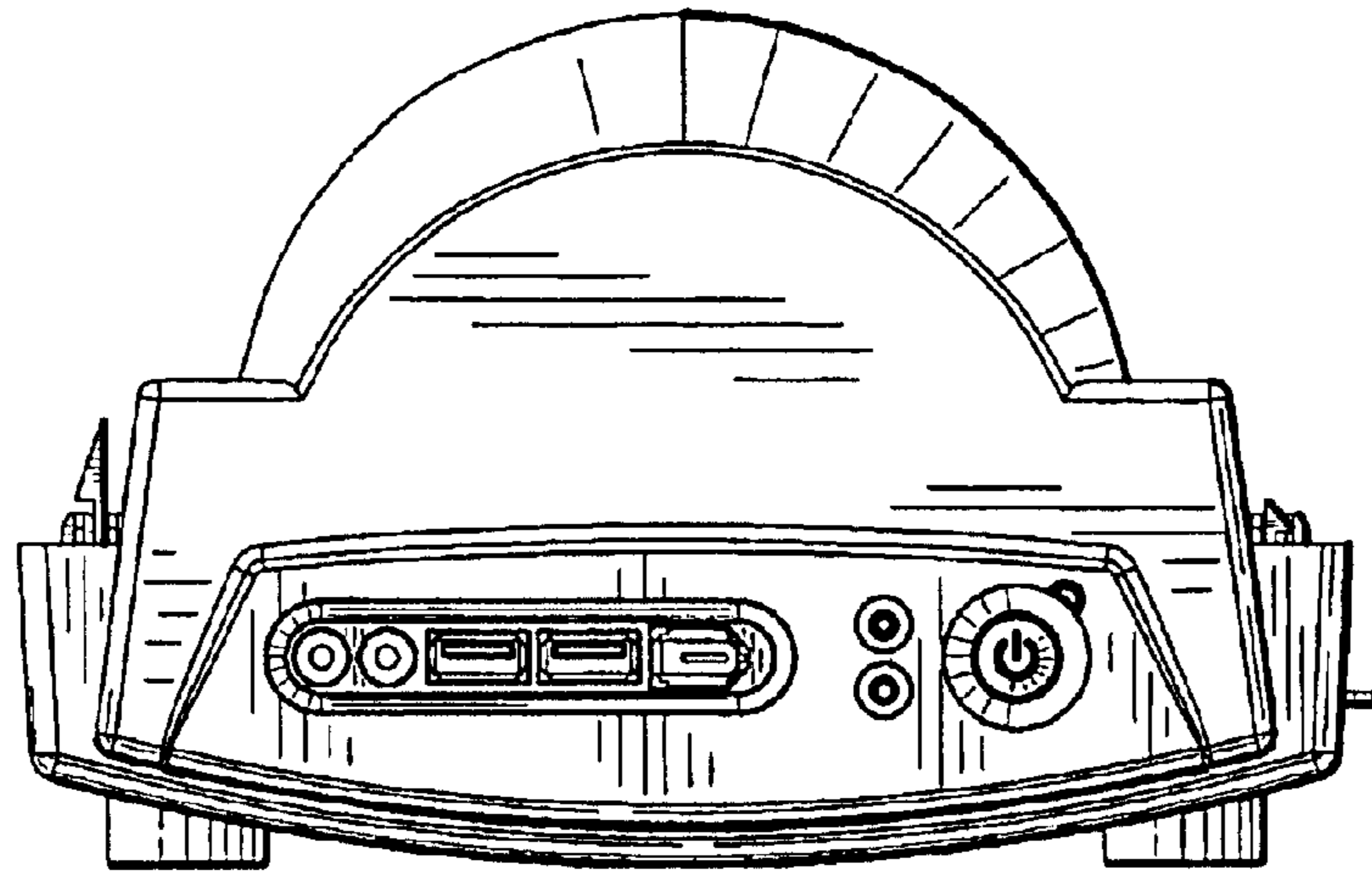


FIG. 6

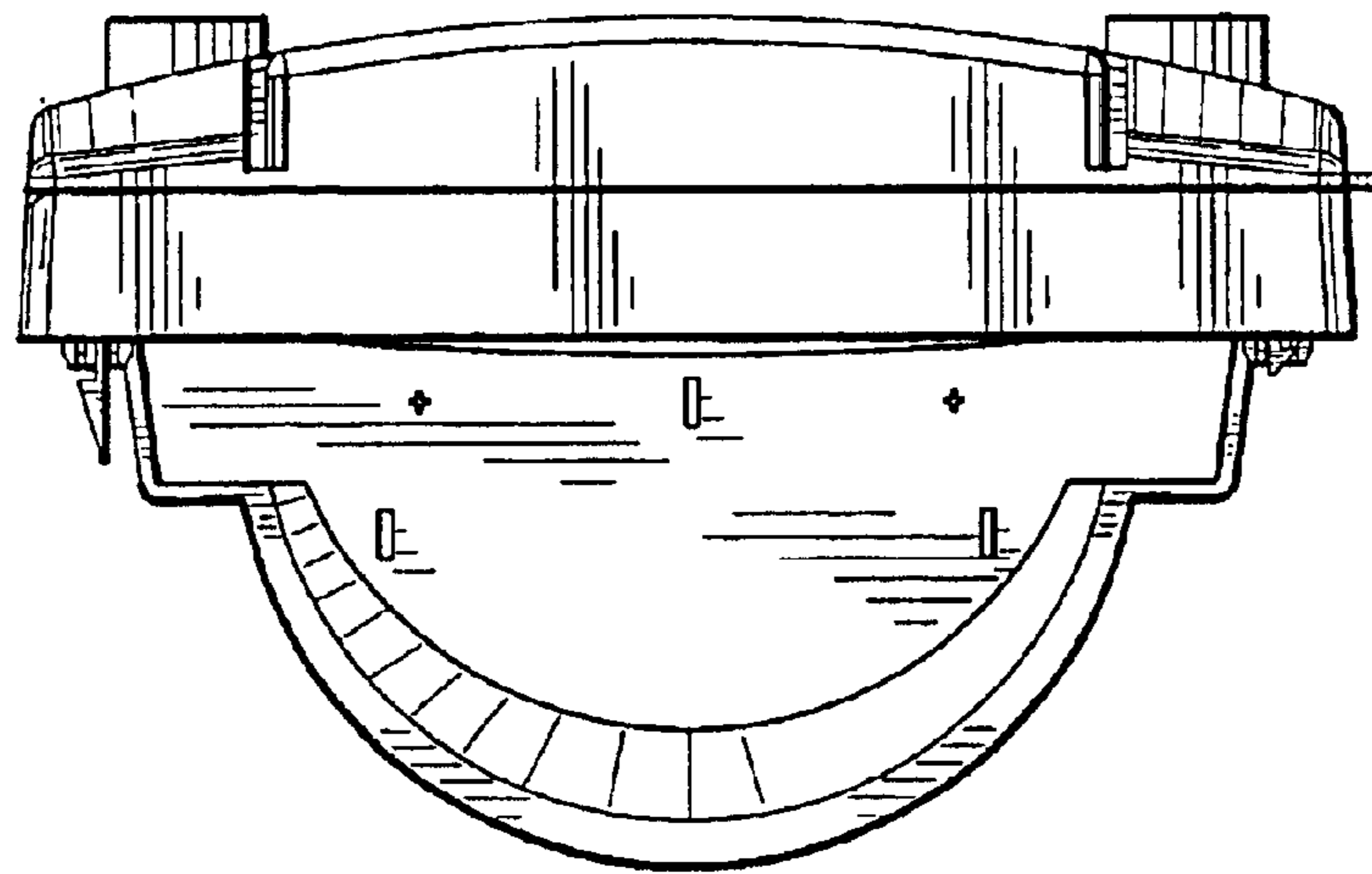


FIG. 7

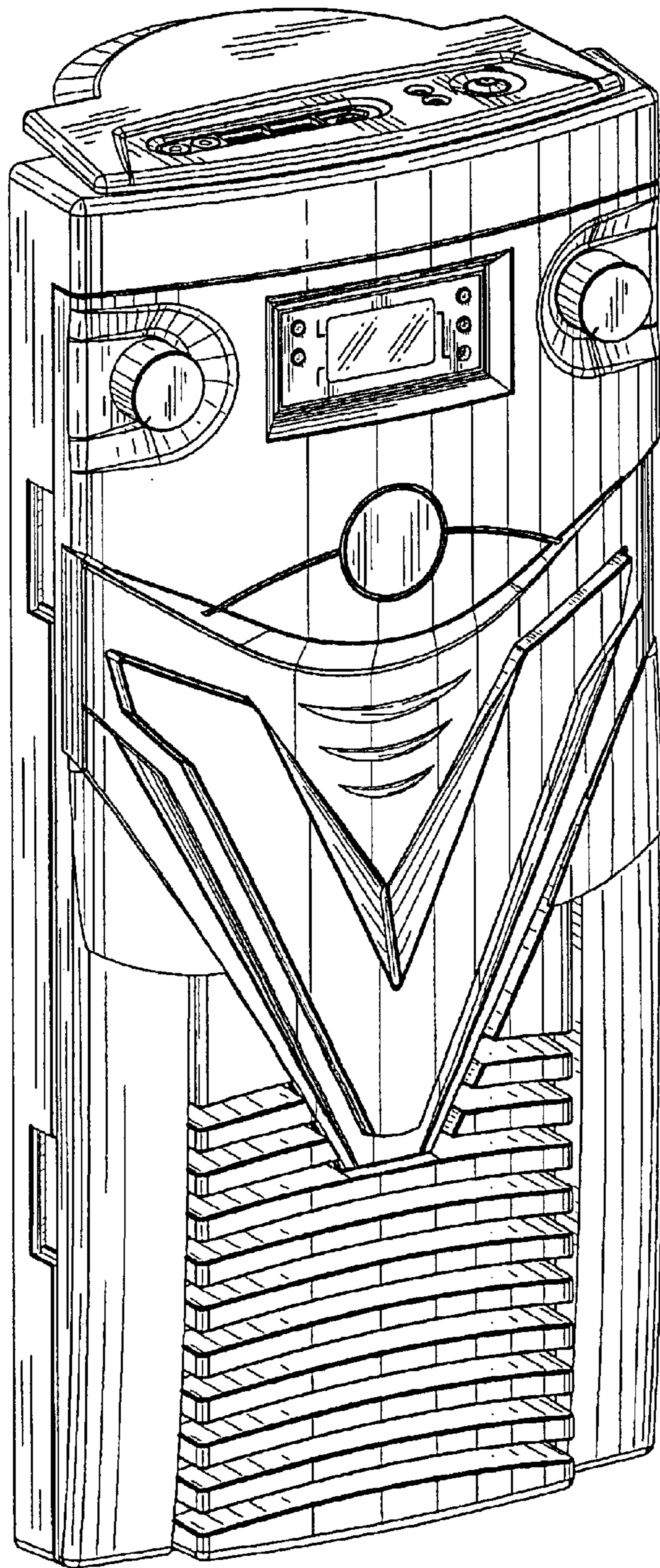


FIG. 8